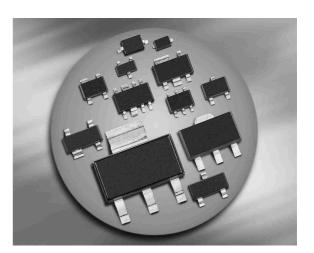


Silicon Schottky Diode

- General-purpose diode for high-speed switching
- Circuit protection
- Voltage clamping

RoHS

- High-level detecting and mixing
- BAS70-04S: For orientation in reel see package information below
- Pb-free (RoHS compliant) package
- Qualified according AEC Q101¹)



Qualified				
BAS170W BAS70-02L BAS70-02W BAS70-02V	BAS70	BAS70-04 BAS70-04W	BAS70-04S	BAS70-05 BAS70-05W
BAS70-06 BAS70-06W	BAS70-07 BAS70-07W			
	4 3 Y D1 Y D2 1 2			
¹ BAS70-02L is not c	qualified according AEC	Q101		

Downloaded from Arrow.com.



BAS70.../BAS170W

Туре	Package	Configuration	L _S (nH)	Marking
BAS170W	SOD323	single	1.8	white 7
BAS70	SOT23	single	1.8	73s
BAS70-02L	TSLP-2-1	single, leadless	0.4	F
BAS70-02V	SC79	single	0.6	С
BAS70-02W*	SCD80	single	0.6	73
BAS70-04	SOT23	series	1.8	74s
BAS70-04S	SOT363	dual series	1.6	74s
BAS70-04W	SOT323	series	1.4	74s
BAS70-05	SOT23	common cathode	1.8	75s
BAS70-05W	SOT323	common cathode	1.4	75s
BAS70-06	SOT23	common anode	1.8	76s
BAS70-06W	SOT323	common anode	1.4	76s
BAS70-07	SOT143	parallel pair	2	77s
BAS70-07W	SOT343	parallel pair	1.8	77s

* Not for new design

Maximum Ratings at T_A = 25 °C, unless otherwise specified

Parameter	Symbol	Value	Unit V	
Diode reverse voltage	V _R	70		
Forward current	I _F	70	mA	
Non-repetitive peak surge forward current	/ _{FSM}	100		
<i>t</i> ≤ 10ms				
Total power dissipation	P _{tot}		mW	
BAS70, BAS70-07, <i>T</i> _S ≤ 72 °C		250		
BAS70-02L, <i>T</i> _S ≤ 117 °C		250		
BAS70-02W, -02V, <i>T</i> _S ≤ 107 °C		250		
BAS70-04, BAS70-06, <i>T</i> _S ≤ 48 °C		250		
BAS70-04S/W/-06W, BAS170W, $T_{S} \le 97 \text{ °C}$		250		
BAS70-05, <i>T</i> _S ≤ 22 °C		250		
BAS70-05W, <i>T</i> _S ≤ 90 °C		250		
BAS70-07W, <i>T</i> _S ≤ 114 °C		250		
Junction temperature	TJ	150	°C	
Operating temperature range	T _{op}	-55 125		
Storage temperature	T _{Stg}	-55 150		



Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point ¹⁾	R _{thJS}		K/W
BAS70, BAS70-07		≤ 310	
BAS70-02L		≤ 130	
BAS70-02W, -02V		≤ 170	
BAS70-04, BAS70-06		≤ 410	
BAS70-04S/W, BAS70-06W		≤ 210	
BAS70-05		≤ 510	
BAS70-05W		≤ 24 0	
BAS70-07W		≤ 145	
BAS170W		≤ 190	

Electrical Characteristics at T_A = 25 °C, unless otherwise specified

Parameter	Symbol		Values		
		min.	typ.	max.]
DC Characteristics	·	·			
Breakdown voltage	V _(BR)	70	-	-	V
/ _(BR) = 10 μA					
Reverse current	I _R	-	-	0.1	μA
V _R = 50 V					
Forward voltage	V _F				mV
<i>I</i> _F = 1 mA		300	375	410	
<i>I</i> _F = 10 mA		600	705	750	
<i>I</i> _F = 15 mA		720	880	1000	
Forward voltage matching ²⁾	ΔV_{F}	-	-	20]
<i>I</i> _F = 10 mA					

¹For calculation of R_{thJA} please refer to Application Note AN077 (Thermal Resistance Calculation) ${}^{2}\Delta V_{\text{F}}$ is the difference between lowest and highest V_{F} in a multiple diode component.

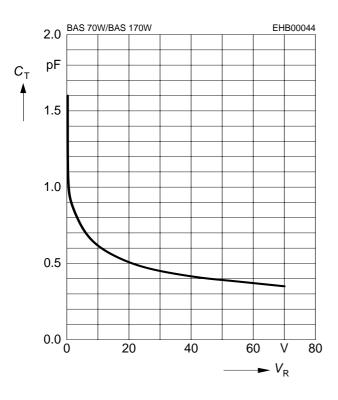


Parameter	Symbol		Values		
		min.	typ.	max.	1
AC Characteristics					
Diode capacitance	CT	-	1.5	2	pF
<i>V</i> _R = 0 , <i>f</i> = 1 MHz					
Forward resistance	r _f	-	34	-	Ω
<i>I</i> _F = 10 mA, <i>f</i> = 10 kHz					
Charge carrier life time	τ _{rr}	-	-	100	ps
<i>I</i> _F = 25 mA					



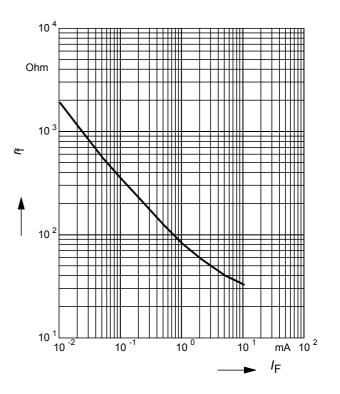
Diode capacitance $C_{T} = f(V_{R})$

f = 1 MHz



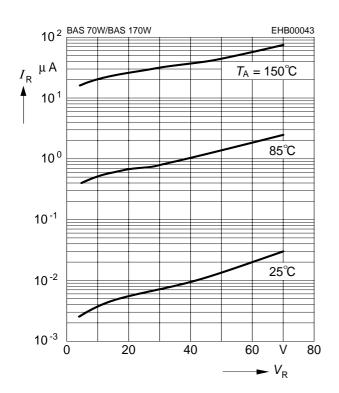
Forward resistance $r_{\rm f} = f (I_{\rm F})$

f = 10 kHz

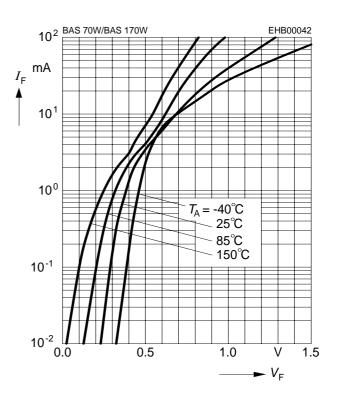


Reverse current $I_{R} = f(V_{R})$

 T_A = Parameter

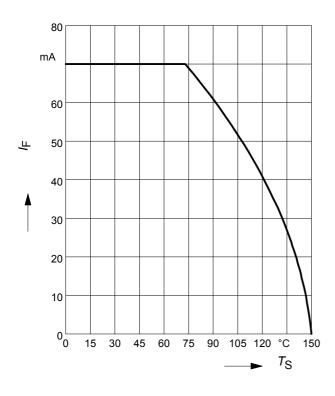


Forward current $I_F = f(V_F)$ T_A = Parameter

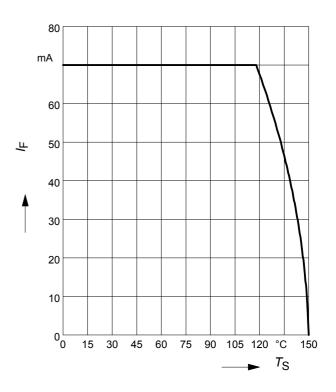




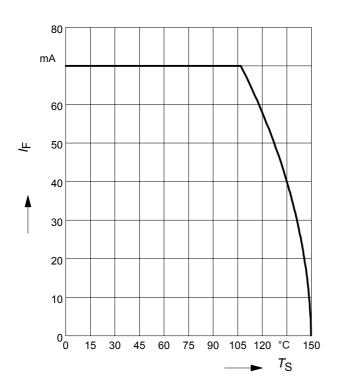
Forward current $I_{F} = f(T_{S})$ BAS70, BAS70-07



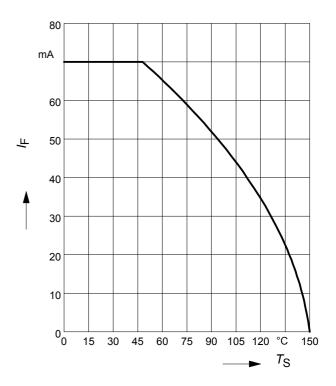
Forward current $I_{F} = f(T_{S})$ BAS70-02L



Forward current $I_F = f(T_S)$ BAS70-02W, -02V

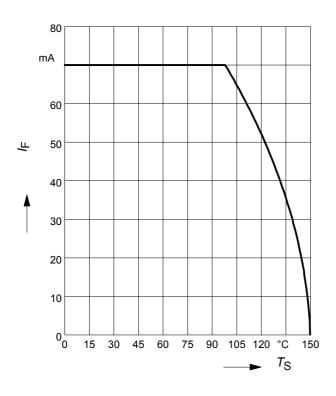


Forward current $I_{F} = f(T_{S})$ BAS70-04, BAS70-06

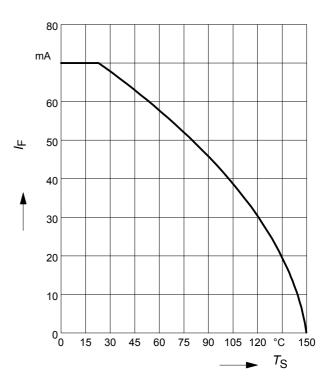




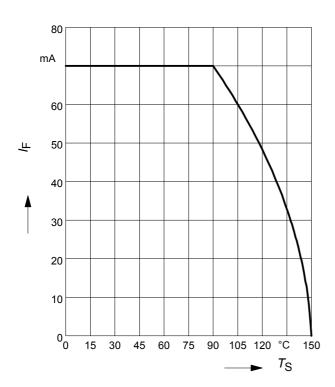
Forward current $I_F = f(T_S)$ BAS70-04S/W, BAS70-06W, BAS170W



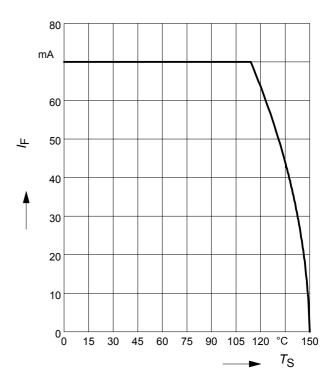
Forward current $I_{F} = f(T_{S})$ BAS70-05



Forward current $I_{F} = f(T_{S})$ BAS70-05W



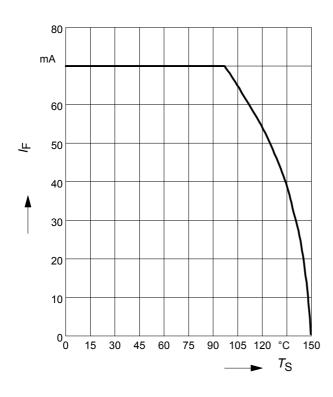
Forward current $I_{F} = f(T_{S})$ BAS70-07W



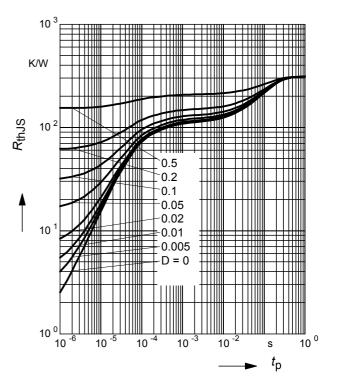


Forward current $I_{F} = f(T_{S})$

BAS170W

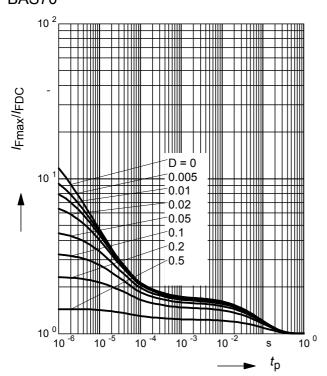


Permissible Puls Load $R_{thJS} = f(t_p)$ BAS70

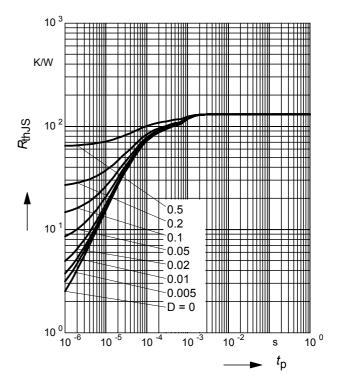


Permissible Pulse Load

 $I_{\text{Fmax}}/I_{\text{FDC}} = f(t_{\text{p}})$ BAS70

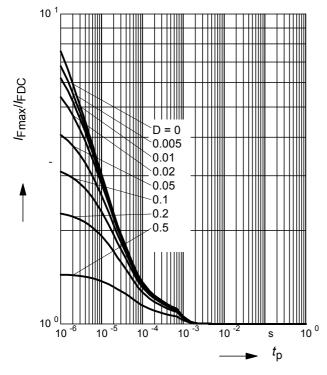


Permissible Puls Load $R_{\text{thJS}} = f(t_p)$ BAS70-02L



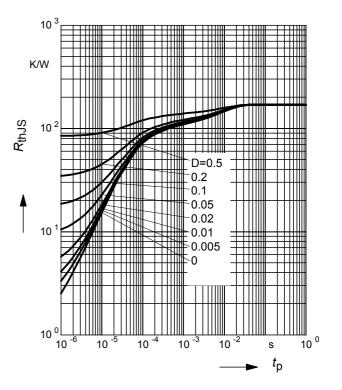


 $I_{\text{Fmax}}/I_{\text{FDC}} = f(t_{\text{p}})$ BAS70-02L



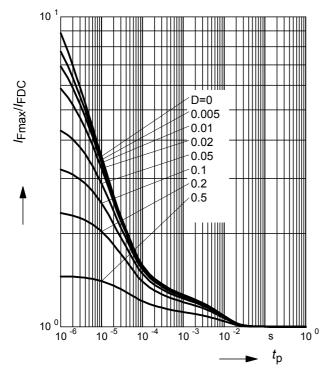
Permissible Puls Load $R_{thJS} = f(t_p)$

BAS70-02W, -02V

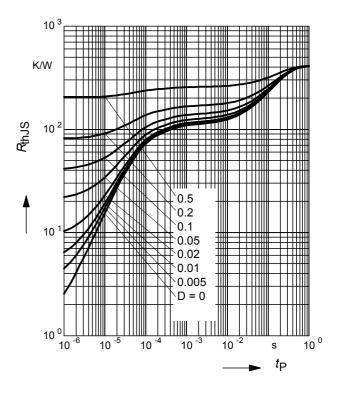


Permissible Pulse Load

 $I_{\text{Fmax}}/I_{\text{FDC}} = f(t_{\text{p}})$ BAS70-02W, -02V

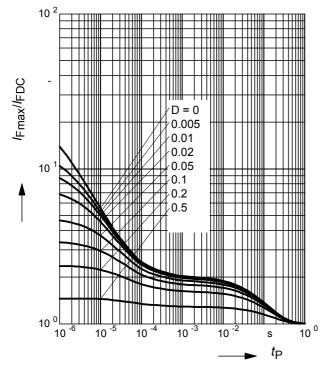


Permissible Puls Load $R_{\text{thJS}} = f(t_p)$ BAS70-04, BAS70-06

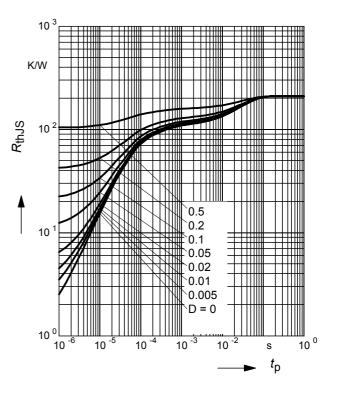




 $I_{\text{Fmax}} / I_{\text{FDC}} = f(t_{\text{p}})$ BAS70-04, BAS70-06

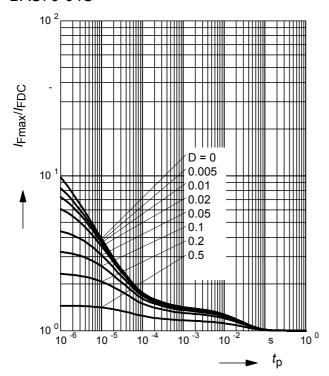


Permissible Puls Load $R_{thJS} = f(t_p)$ BAS70-04S

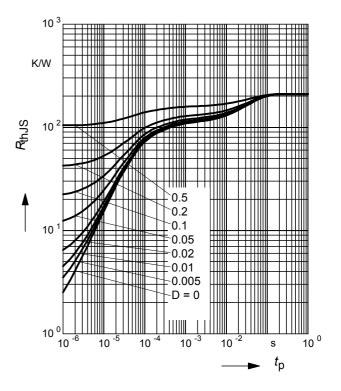


Permissible Pulse Load

 $I_{\text{Fmax}}/I_{\text{FDC}} = f(t_{\text{p}})$ BAS70-04S

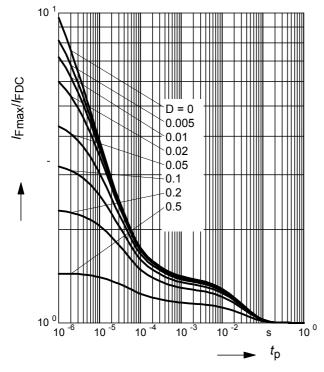


Permissible Puls Load $R_{\text{thJS}} = f(t_p)$ BAS70-04W, BAS70-06W

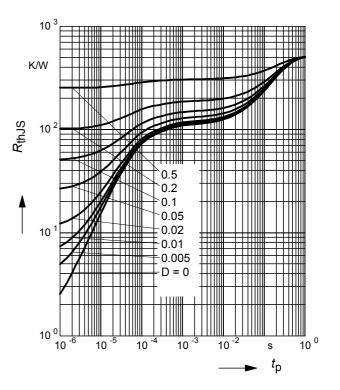




 $I_{\text{Fmax}}/I_{\text{FDC}} = f(t_{\text{p}})$ BAS70-04W, BAS70-06W

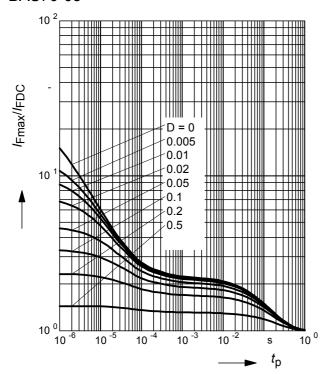


Permissible Puls Load $R_{thJS} = f(t_p)$ BAS70-05

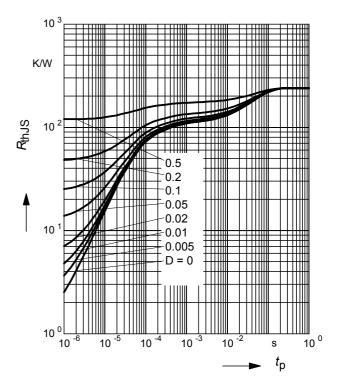


Permissible Pulse Load

 $I_{\text{Fmax}}/I_{\text{FDC}} = f(t_{\text{p}})$ BAS70-05

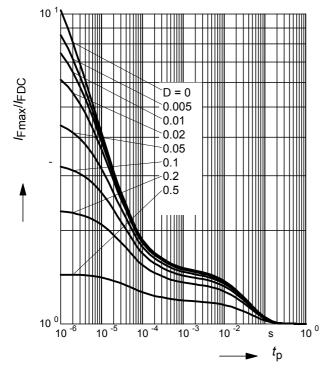


Permissible Puls Load $R_{\text{thJS}} = f(t_p)$ BAS70-05W

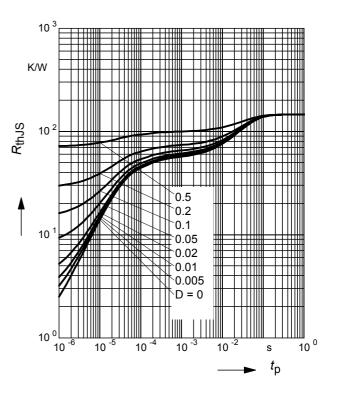




 $I_{\text{Fmax}}/I_{\text{FDC}} = f(t_{\text{p}})$ BAS70-05W

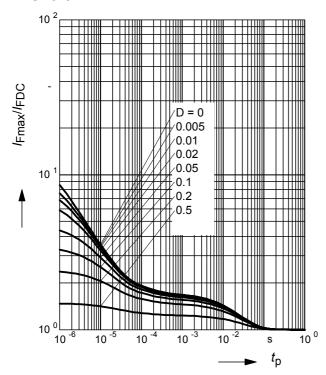


Permissible Puls Load $R_{thJS} = f(t_p)$ BAS70-07W

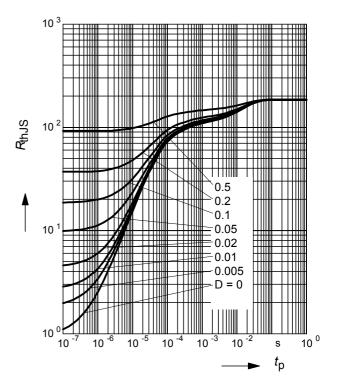


Permissible Pulse Load

 $I_{\text{Fmax}}/I_{\text{FDC}} = f(t_{\text{p}})$ BAS70-07W

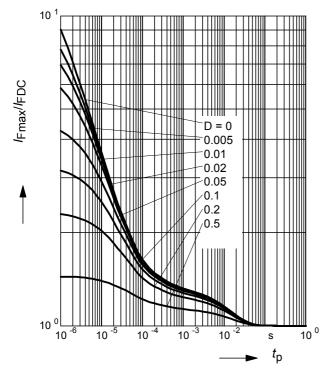


Permissible Puls Load $R_{\text{thJS}} = f(t_p)$ BAS170W

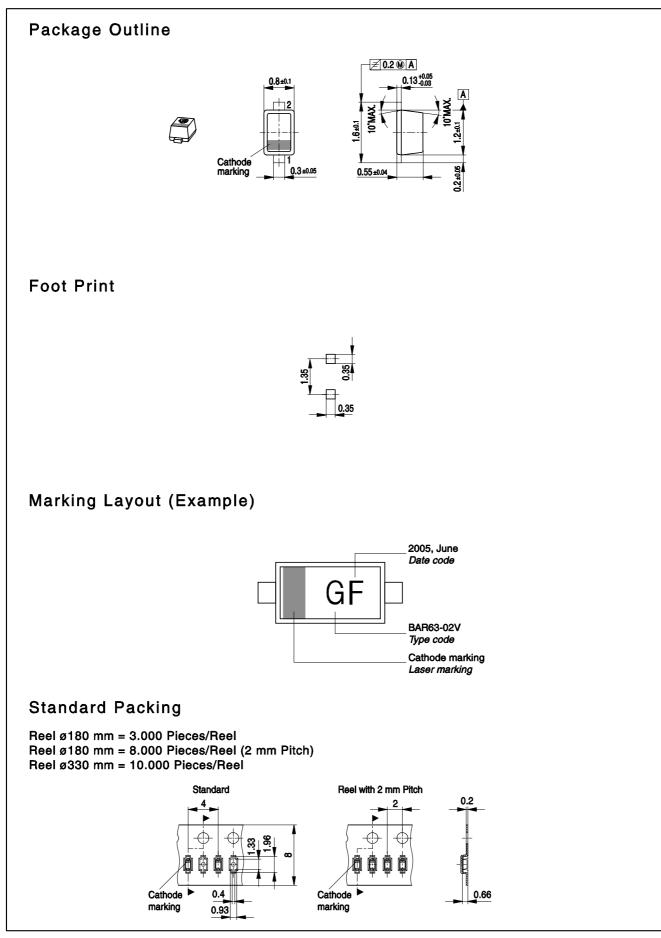




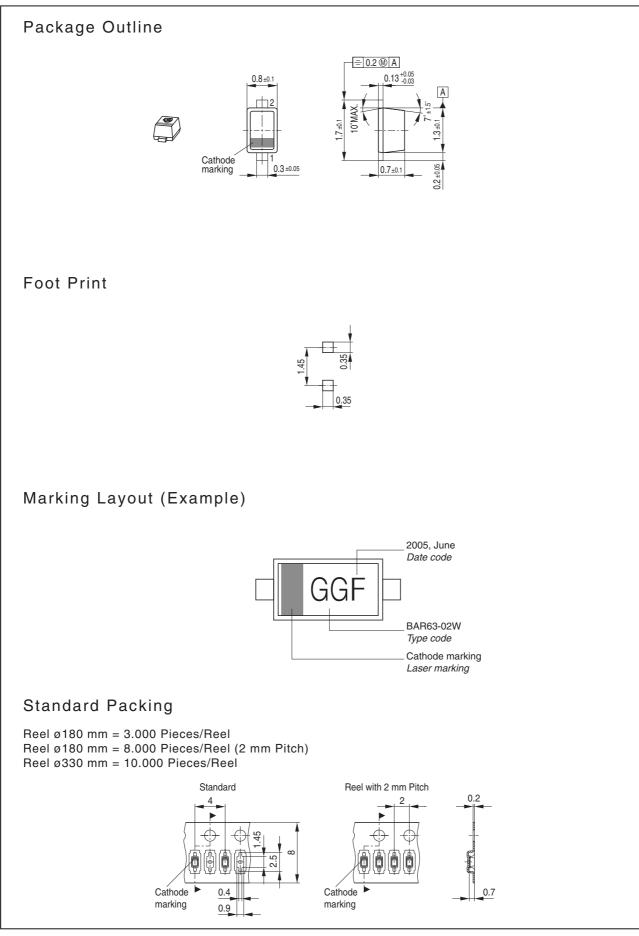
 $I_{\text{Fmax}}/I_{\text{FDC}} = f(t_{\text{p}})$ BAS170W











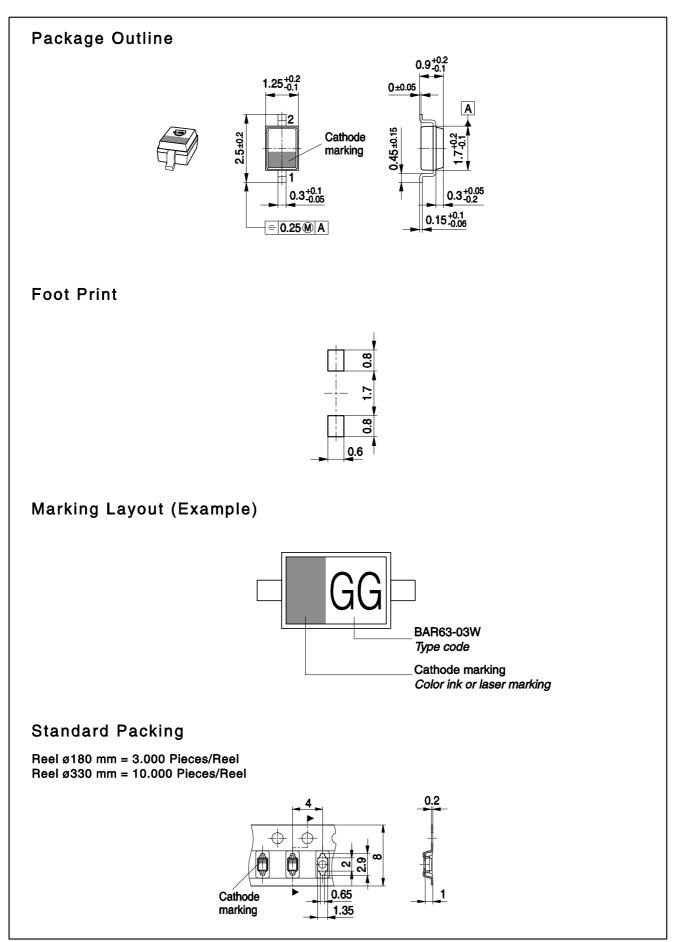


Date Code marking for discrete packages with one digit (SCD80, SC79, SC75¹) CES-Code

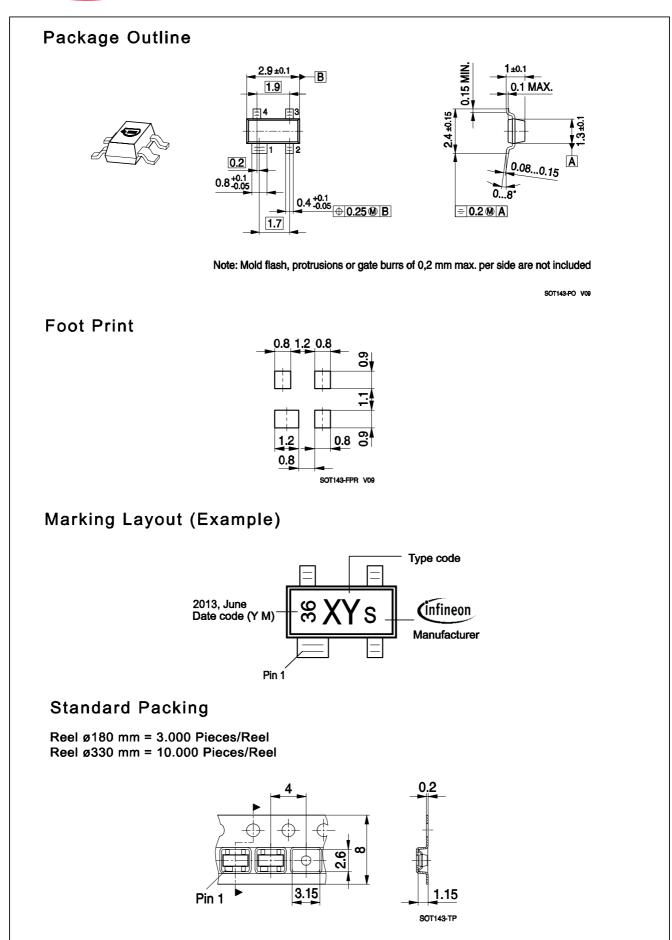
Month	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012	2013	2014
01	а	р	А	Р	а	р	А	Р	а	р	А	Р
02	b	q	В	Q	b	q	В	Q	b	q	В	Q
03	С	r	С	R	С	r	С	R	С	r	С	R
04	d	S	D	S	d	S	D	S	d	S	D	S
05	е	t	E	Т	е	t	E	Т	е	t	Е	Т
06	f	u	F	U	f	u	F	U	f	u	F	U
07	g	V	G	V	g	V	G	V	g	V	G	V
08	h	х	Н	Х	h	х	Н	Х	h	х	Н	Х
09	j	у	J	Y	j	у	J	Y	j	у	J	Y
10	k	Z	K	Z	k	Z	K	Z	k	Z	K	Z
11	I	2	L	4	I	2	L	4	I	2	L	4
12	n	3	Ν	5	n	3	Ν	5	n	3	Ν	5

1) New Marking Layout for SC75, implemented at October 2005.

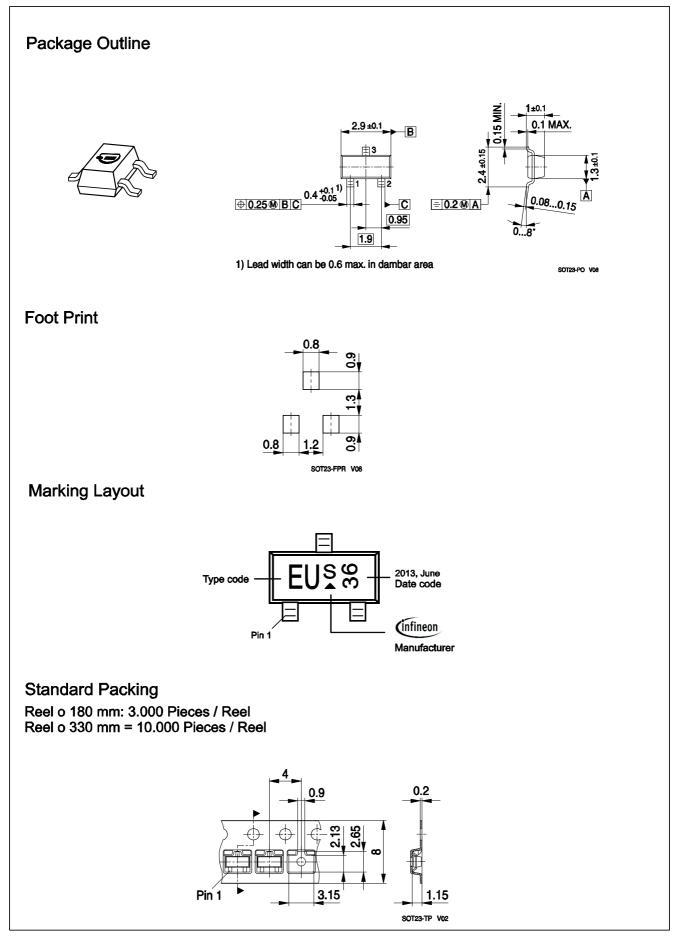




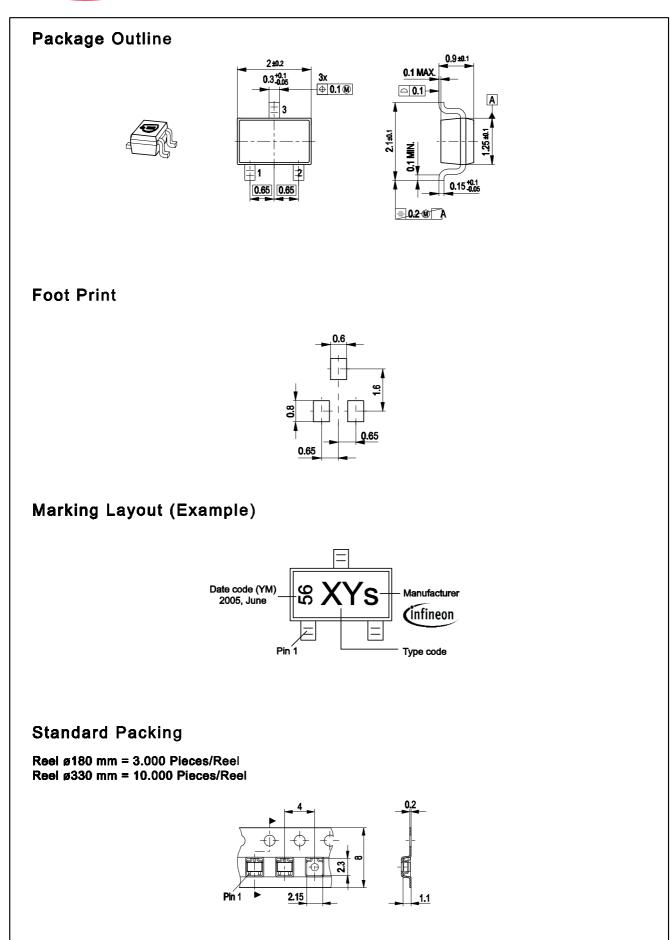




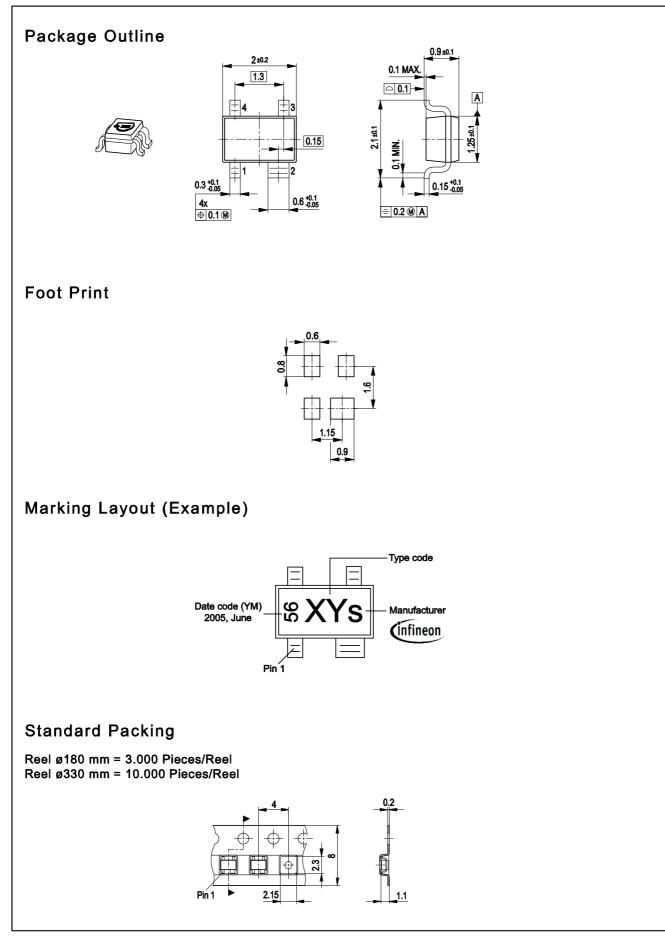




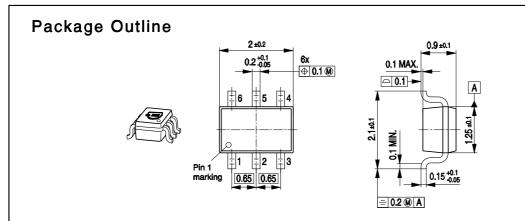




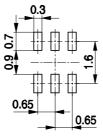






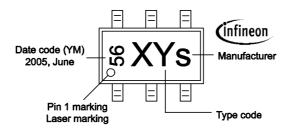


Foot Print



Marking Layout (Example)

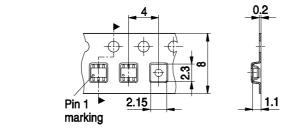
Small variations in positioning of Date code, Type code and Manufacture are possible.



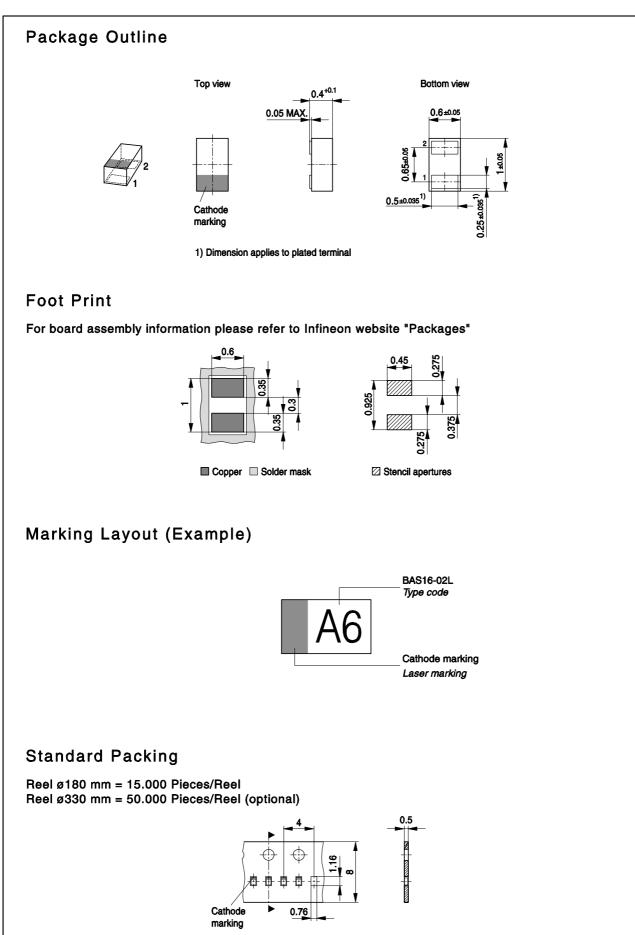
Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel Reel ø330 mm = 10.000 Pieces/Reel

For symmetric types no defined Pin 1 orientation in reel.









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